# 3.3 V/5 V ECL $\div$ 4 Divider

# Description

The MC10/100EP33 is an integrated  $\div 4$  divider. The differential clock inputs.

The V<sub>BB</sub> pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V<sub>BB</sub> as a switching reference voltage. V<sub>BB</sub> may also rebias AC coupled inputs. When used, decouple V<sub>BB</sub> and  $V_{CC}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V<sub>BB</sub> should be left open.

The reset pin is asynchronous and is asserted on the rising edge. Upon powerup, the internal flip-flops will attain a random state; the reset allows for the synchronization of multiple EP33's in a system.

The 100 Series contains temperature compensation.

## **Features**

- 320 ps Propagation Delay
- Maximum Frequency = > 4 GHz Typical
- PECL Mode Operating Range:  $V_{CC} = 3.0 \text{ V}$  to 5.5 V with  $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range:  $V_{CC} = 0 \text{ V}$  with  $V_{EE} = -3.0 \text{ V}$  to -5.5 V
- Open Input Default State
- Safety Clamp on Inputs
- Q Output Will Default LOW with Inputs Open or at V<sub>EE</sub>
- V<sub>BB</sub> Output
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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SOIC-8 NB **D SUFFIX** 

TSSOP-8 DT SUFFIX CASE 751-07 CASE 948R-02 CASE 506AA

DFN8 **MN SUFFIX** 

## **MARKING DIAGRAMS\***













SOIC-8 NB

TSSOP-8

DFN8

= MC10 A = Assembly Location = MC100 L = Wafer Lot

5Q = MC10 Υ = Year = MC100 W = Work Week

= Date Code = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

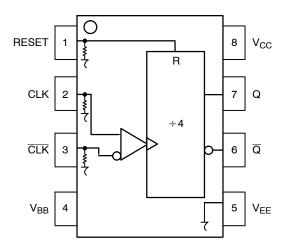


Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

# **Table 1. PIN DESCRIPTION**

| PIN             | FUNCTION   |
|-----------------|--|
| CLK*, CLK*      | ECL Clock Inputs   |
| Reset*          | ECL Asynchronous Reset   |
| $V_{BB}$        | Reference Voltage Output   |
| Q, Q            | ECL Data Outputs   |
| V <sub>CC</sub> | Positive Supply  |
| V <sub>EE</sub> | Negative Supply  |
| EP              | (DFN8 only) Thermal exposed pad must<br>be connected to a sufficient thermal con-<br>duit. Electrically connect to the most neg-<br>ative supply (GND) or leave unconnected,<br>floating open. |

<sup>\*</sup> Pins will default LOW when left open.

**Table 2. TRUTH TABLE** 

| CLK | CLK | RESET | ø | Q |
|-----|-----|-------|---|---|
| X   | X   | Z     | L | H |
| Z   | Z   | L     | F | F |

Z = LOW to HIGH Transition

 $\overline{Z}$  = HIGH to LOW Transition

F = Divide by 4 Function

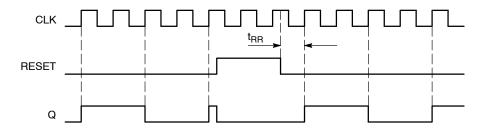


Figure 2. Timing Diagram

**Table 3. ATTRIBUTES** 

| Characteristics  | Value                         |    |  |  |  |  |  |
|--|-------------------------------|----|--|--|--|--|--|
| Internal Input Pulldown Resistor                                   | 75 kΩ                         |    |  |  |  |  |  |
| Internal Input Pullup Resistor                                     | NA                            |    |  |  |  |  |  |
| ESD Protection Human Body Model Machine Model Charged Device Model | > 4 kV<br>> 200 V<br>> 2 kV   |    |  |  |  |  |  |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)      | Pb-Free Pkg                   |    |  |  |  |  |  |
| SOIC-8 NB<br>TSSOP-8<br>DFN8                                       | Level 1<br>Level 3<br>Level 1 |    |  |  |  |  |  |
| Flammability Rating Oxygen Index: 28 to 34                         | UL-94 V-0 @ 0.125             | in |  |  |  |  |  |
| Transistor Count   | 91 Devices                    |    |  |  |  |  |  |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test             |                               |    |  |  |  |  |  |

<sup>1.</sup> For additional information, see Application Note AND8003/D.

**Table 4. MAXIMUM RATINGS** 

| Symbol            | Parameter  | Condition 1                                    | Condition 2   | Rating      | Unit |
|-------------------|--|--|---|-------------|------|
| V <sub>CC</sub>   | PECL Mode Power Supply                             | V <sub>EE</sub> = 0 V                          |   | 6           | V    |
| V <sub>EE</sub>   | NECL Mode Power Supply                             | V <sub>CC</sub> = 0 V                          |   | -6          | V    |
| VI                | PECL Mode Input Voltage<br>NECL Mode Input Voltage | V <sub>EE</sub> = 0 V<br>V <sub>CC</sub> = 0 V | $\begin{array}{c} V_I \leq V_{CC} \\ V_I \geq V_{EE} \end{array}$ | 6<br>-6     | V    |
| I <sub>out</sub>  | Output Current                                     | Continuous<br>Surge                            |   | 50<br>100   | mA   |
| I <sub>BB</sub>   | V <sub>BB</sub> Sink/Source                        |  |   | ±0.5        | mA   |
| T <sub>A</sub>    | Operating Temperature Range                        |  |   | -40 to +85  | °C   |
| T <sub>stg</sub>  | Storage Temperature Range                          |  |   | -65 to +150 | °C   |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | SOIC-8 NB<br>SOIC-8 NB  | 190<br>130  | °C/W |
| θЈС               | Thermal Resistance (Junction-to-Case)              | Standard Board                                 | SOIC-8 NB   | 41 to 44    | °C/W |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | TSSOP-8<br>TSSOP-8  | 185<br>140  | °C/W |
| $\theta_{\sf JC}$ | Thermal Resistance (Junction-to-Case)              | Standard Board                                 | TSSOP-8   | 41 to 44    | °C/W |
| T <sub>sol</sub>  | Wave Solder  | < 2 to 3 sec @ 248°C                           |   | 265         | °C   |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | DFN8<br>DFN8  | 129<br>84   | °C/W |
| T <sub>sol</sub>  | Wave Solder (Pb-Free)                              | < 2 to 3 sec @ 260°C                           |   | 265         | °C   |
| θЈС               | Thermal Resistance (Junction-to-Case)              | (Note 2)                                       | DFN8  | 35 to 40    | °C/W |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 5. 10EP DC CHARACTERISTICS, PECL ( $V_{CC} = 3.3 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 1))

|                    |   |      | -40°C |      |      | 25°C |      |      | 85°C |      |      |
|--------------------|---|------|-------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic  | Min  | Тур   | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current  | 18   | 26    | 40   | 18   | 26   | 40   | 18   | 26   | 40   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)  | 2165 | 2290  | 2415 | 2230 | 2355 | 2480 | 2290 | 2415 | 2540 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)   | 1365 | 1490  | 1615 | 1430 | 1555 | 1680 | 1490 | 1615 | 1740 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)   | 2090 |       | 2415 | 2155 |      | 2480 | 2215 |      | 2540 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)  | 1365 |       | 1690 | 1430 |      | 1755 | 1490 |      | 1815 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference  | 1790 | 1890  | 1990 | 1855 | 1955 | 2055 | 1915 | 2015 | 2115 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration) (Note 3) | 2.0  |       | 3.3  | 2.0  |      | 3.3  | 2.0  |      | 3.3  | V    |
| I <sub>IH</sub>    | Input HIGH Current  |      |       | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current   | 0.5  |       |      | 0.5  |      |      | 0.5  |      |      | μА   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.3 V to -2.2 V.
- All loading with 50 Ω to V<sub>CC</sub> 2.0 V.
   V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

<sup>2.</sup> JEDEC standard multilayer board - 2S2P (2 signal, 2 power)

Table 6. 10EP DC CHARACTERISTICS, PECL ( $V_{CC} = 5.0 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 1))

|                    |   |      | -40°C |      |      | 25°C |      |      | 85°C |      |      |
|--------------------|---|------|-------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic  | Min  | Тур   | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current  | 18   | 26    | 40   | 18   | 26   | 40   | 18   | 26   | 40   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)  | 3865 | 3990  | 4115 | 3930 | 4055 | 4180 | 3990 | 4115 | 4240 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)   | 3065 | 3190  | 3315 | 3130 | 3255 | 3380 | 3190 | 3315 | 3440 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)   | 3790 |       | 4115 | 3855 |      | 4180 | 3915 |      | 4240 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)  | 3065 |       | 3390 | 3130 |      | 3455 | 3190 |      | 3515 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference  | 3490 | 3590  | 3690 | 3555 | 3655 | 3755 | 3615 | 3715 | 3815 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration) (Note 3) | 2.0  |       | 5.0  | 2.0  |      | 5.0  | 2.0  |      | 5.0  | V    |
| I <sub>IH</sub>    | Input HIGH Current  |      |       | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current   | 0.5  |       |      | 0.5  |      |      | 0.5  |      |      | μА   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +2.0 V to -0.5 V.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0  $V_{CC}$  and  $V_{CC}$  = 2.0  $V_{CC}$

Table 7. 10EP DC CHARACTERISTICS, NECL (V<sub>CC</sub> = 0 V; V<sub>EE</sub> = -5.5 V to -3.0 V (Note 1))

|                 |  |                   | -40°C |       |                 | 25°C  |       |                 | 85°C  |       |      |
|-----------------|--|-------------------|-------|-------|-----------------|-------|-------|-----------------|-------|-------|------|
| Symbol          | Characteristic   | Min               | Тур   | Max   | Min             | Тур   | Max   | Min             | Тур   | Max   | Unit |
| I <sub>EE</sub> | Power Supply Current   | 18                | 26    | 40    | 18              | 26    | 40    | 18              | 26    | 40    | mA   |
| VOH             | Output HIGH Voltage (Note 2)   | -1135             | -1010 | -885  | -1070           | -945  | -820  | -1010           | -885  | -760  | mV   |
| V <sub>OL</sub> | Output LOW Voltage (Note 2)  | -1935             | -1810 | -1685 | -1870           | -1745 | -1620 | -1810           | -1685 | -1560 | mV   |
| V <sub>IH</sub> | Input HIGH Voltage (Single-Ended)  | -1210             |       | -885  | -1145           |       | -820  | -1085           |       | -760  | mV   |
| V <sub>IL</sub> | Input LOW Voltage (Single-Ended)   | -1935             |       | -1610 | -1870           |       | -1545 | -1810           |       | -1485 | mV   |
| V <sub>BB</sub> | Output Voltage Reference   | -1510             | -1410 | -1310 | -1445           | -1345 | -1245 | -1385           | -1285 | -1185 | mV   |
| VIHCMR          | Input HIGH Voltage Common Mode<br>Range (Differential Configuration)<br>(Note 3) | V <sub>EE</sub> - | +2.0  | 0.0   | V <sub>EE</sub> | +2.0  | 0.0   | V <sub>EE</sub> | +2.0  | 0.0   | V    |
| I <sub>IH</sub> | Input HIGH Current   |                   |       | 150   |                 |       | 150   |                 |       | 150   | μΑ   |
| I <sub>IL</sub> | Input LOW Current  | 0.5               |       |       | 0.5             |       |       | 0.5             |       |       | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with  $V_{\mbox{\footnotesize CC}}$ .
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- 3. VIHCMR min varies 1:1 with VEE, VIHCMR max varies 1:1 with VCC. The VIHCMR range is referenced to the most positive side of the differential input signal.

Table 8. 100EP DC CHARACTERISTICS, PECL ( $V_{CC} = 3.3 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 1))

|                    |   |      | -40°C |      |      | 25°C |      |      | 85°C |      |      |
|--------------------|---|------|-------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic  | Min  | Тур   | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current  | 18   | 26    | 40   | 23   | 26   | 45   | 23   | 26   | 45   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)  | 2155 | 2280  | 2405 | 2155 | 2280 | 2405 | 2155 | 2280 | 2405 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)   | 1355 | 1480  | 1605 | 1355 | 1480 | 1605 | 1355 | 1480 | 1605 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)   | 2075 |       | 2420 | 2075 |      | 2420 | 2075 |      | 2420 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)  | 1355 |       | 1675 | 1355 |      | 1675 | 1355 |      | 1675 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference  | 1775 | 1875  | 1975 | 1775 | 1875 | 1975 | 1775 | 1875 | 1975 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration) (Note 3) | 2.0  |       | 3.3  | 2.0  |      | 3.3  | 2.0  |      | 3.3  | ٧    |
| I <sub>IH</sub>    | Input HIGH Current  |      |       | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current   | 0.5  |       |      | 0.5  |      |      | 0.5  |      |      | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.3 V to -2.2 V.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0  $V_{CC}$  and  $V_{CC}$  2.0  $V_{CC}$  2.0  $V_{CC}$  and  $V_{CC}$  2.0  $V_{CC}$

Table 9. 100EP DC CHARACTERISTICS, PECL ( $V_{CC} = 5.0 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 1))

|                    |   |      | -40°C |      |      | 25°C |      |      | 85°C |      |      |
|--------------------|---|------|-------|------|------|------|------|------|------|------|------|
| Symbol             | Characteristic  | Min  | Тур   | Max  | Min  | Тур  | Max  | Min  | Тур  | Max  | Unit |
| I <sub>EE</sub>    | Power Supply Current  | 18   | 26    | 40   | 23   | 26   | 45   | 23   | 26   | 45   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)  | 3855 | 3980  | 4105 | 3855 | 3980 | 4105 | 3855 | 3980 | 4105 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)   | 3055 | 3180  | 3305 | 3055 | 3180 | 3305 | 3055 | 3180 | 3305 | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)   | 3775 |       | 4120 | 3775 |      | 4120 | 3775 |      | 4120 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)  | 3055 |       | 3375 | 3055 |      | 3375 | 3055 |      | 3375 | mV   |
| V <sub>BB</sub>    | Output Voltage Reference  | 3475 | 3575  | 3675 | 3475 | 3575 | 3675 | 3475 | 3575 | 3675 | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration) (Note 3) | 2.0  |       | 5.0  | 2.0  |      | 5.0  | 2.0  |      | 5.0  | V    |
| I <sub>IH</sub>    | Input HIGH Current  |      |       | 150  |      |      | 150  |      |      | 150  | μΑ   |
| I <sub>IL</sub>    | Input LOW Current   | 0.5  |       |      | 0.5  |      |      | 0.5  |      |      | μΑ   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +2.0 V to -0.5 V.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- 3. VIHCMR min varies 1:1 with VEE, VIHCMR max varies 1:1 with VCC. The VIHCMR range is referenced to the most positive side of the differential input signal.

Table 10. 100EP DC CHARACTERISTICS, NECL ( $V_{CC} = 0 \text{ V}$ ;  $V_{EE} = -5.5 \text{ V}$  to -3.0 V (Note 1))

|                    |  |                   | -40°C |       |                 | 25°C  |       |                 | 85°C  |       |             |
|--------------------|--|-------------------|-------|-------|-----------------|-------|-------|-----------------|-------|-------|-------------|
| Symbol             | Characteristic   | Min               | Тур   | Max   | Min             | Тур   | Max   | Min             | Тур   | Max   | Unit        |
| I <sub>EE</sub>    | Power Supply Current   | 18                | 26    | 40    | 23              | 26    | 45    | 23              | 26    | 45    | mA          |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 2)   | -1145             | -1020 | -895  | -1145           | -1020 | -895  | -1145           | -1020 | -895  | mV          |
| V <sub>OL</sub>    | Output LOW Voltage (Note 2)  | -1945             | -1820 | -1695 | -1945           | -1820 | -1695 | -1945           | -1820 | -1695 | mV          |
| V <sub>IH</sub>    | Input HIGH Voltage (Single-Ended)  | -1225             |       | -880  | -1225           |       | -880  | -1225           |       | -880  | mV          |
| V <sub>IL</sub>    | Input LOW Voltage (Single-Ended)   | -1945             |       | -1625 | -1945           |       | -1625 | -1945           |       | -1625 | mV          |
| V <sub>BB</sub>    | Output Voltage Reference   | -1525             | -1425 | -1325 | -1525           | -1425 | -1325 | -1525           | -1425 | -1325 | mV          |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode<br>Range (Differential Configuration)<br>(Note 3) | V <sub>EE</sub> - | +2.0  | 0.0   | V <sub>EE</sub> | +2.0  | 0.0   | V <sub>EE</sub> | +2.0  | 0.0   | <b>&gt;</b> |
| I <sub>IH</sub>    | Input HIGH Current   |                   |       | 150   |                 |       | 150   |                 |       | 150   | μΑ          |
| I <sub>IL</sub>    | Input LOW Current  | 0.5               |       |       | 0.5             |       |       | 0.5             |       |       | μΑ          |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with V<sub>CC</sub>.
- 2. All loading with 50  $\Omega$  to  $V_{CC}$  2.0 V.
- 3. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

Table 11. AC CHARACTERISTICS (V<sub>CC</sub> = 0 V; V<sub>EE</sub> = -3.0 V to -5.5 V or V<sub>CC</sub> = 3.0 V to 5.5 V; V<sub>EE</sub> = 0 V (Note 1))

|  |   |            | -40°C      |            |            | 25°C       |            |            | 85°C       |            |      |
|--|---|------------|------------|------------|------------|------------|------------|------------|------------|------------|------|
| Symbol                                 | Characteristic  | Min        | Тур        | Max        | Min        | Тур        | Max        | Min        | Тур        | Max        | Unit |
| V <sub>OPP</sub>                       | Output Voltage Amplitude (See Figure 4)<br>f <sub>in</sub> < 4.0 GHz<br>f <sub>in</sub> < 4.5 GHz |            | 700<br>600 |            |            | 700<br>600 |            |            | 700<br>600 |            | mV   |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Propagation Delay to<br>CLK/Q<br>Output Differential<br>RESET/Q                                   | 300<br>370 | 380<br>420 | 440<br>470 | 300<br>370 | 380<br>420 | 440<br>470 | 320<br>400 | 400<br>450 | 460<br>500 | ps   |
| t <sub>RR</sub>                        | Set/Rest Recovery   | 150        | 100        |            | 200        | 100        |            | 200        | 100        |            | ps   |
| t <sub>PW</sub>                        | Minimum Pulse width RESET   | 550        | 480        |            | 550        | 480        |            | 550        | 480        |            | ps   |
| t <sub>JITTER</sub>                    | Random Clock Jitter (RMS)   |            | 0.2        | 2          |            | 0.2        | 2          |            | 0.2        | 2          | ps   |
| V <sub>PP</sub>                        | Input Voltage Swing<br>(Differential Configuration)   | 150        | 800        | 1200       | 150        | 800        | 1200       | 150        | 800        | 1200       | mV   |
| t <sub>r</sub><br>t <sub>f</sub>       | Output Rise/Fall Times<br>Q, Q (20%–80%)  | 90         | 170        | 200        | 100        | 180        | 250        | 120        | 200        | 280        | ps   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

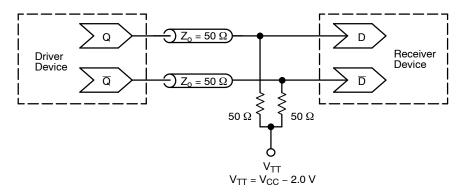


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note <u>AND8020/D</u> – Termination of ECL Logic Devices)

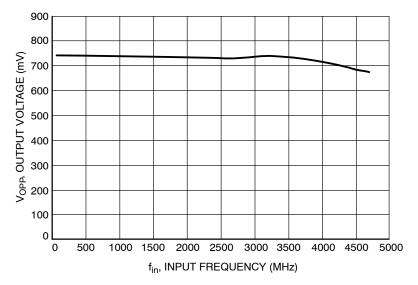


Figure 4. Input Frequency ( $f_{in}$ ) versus Output Voltage ( $V_{OPP}$ )

# **ORDERING INFORMATION**

| Device         | Package                | Shipping <sup>†</sup> |
|----------------|------------------------|-----------------------|
| MC10EP33DG     | SOIC-8 NB<br>(Pb-Free) | 98 Units / Tube       |
| MC10EP33DR2G   | SOIC-8 NB<br>(Pb-Free) | 2500 / Tape & Reel    |
| MC10EP33DTG    | TSSOP-8<br>(Pb-Free)   | 100 Units / Tube      |
| MC10EP33DTR2G  | TSSOP-8<br>(Pb-Free)   | 2500 / Tape & Reel    |
| MC10EP33MNR4G  | DFN8<br>(Pb-Free)      | 1000 / Tape & Reel    |
| MC100EP33DG    | SOIC-8 NB<br>(Pb-Free) | 98 Units / Tube       |
| MC100EP33DR2G  | SOIC-8 NB<br>(Pb-Free) | 2500 / Tape & Reel    |
| MC100EP33DTG   | TSSOP-8<br>(Pb-Free)   | 100 Units / Tube      |
| MC100EP33DTR2G | TSSOP-8<br>(Pb-Free)   | 2500 / Tape & Reel    |
| MC100EP33MNR4G | DFN8<br>(Pb-Free)      | 1000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.

# **Resource Reference of Application Notes**

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

 $\textbf{AN1503/D} \qquad - \quad \text{ECLinPS} \ ^{\text{\tiny{TM}}} \ \text{I/O SPiCE Modeling Kit}$ 

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

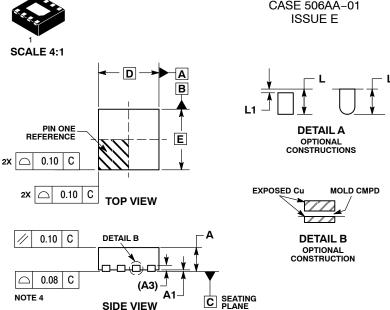
AND8090/D - AC Characteristics of ECL Devices

DETAIL A

е

- D2 →

**BOTTOM VIEW** 



0.10 C

Ф

AB

0.05 C NOTE 3



**DATE 22 JAN 2010** 

### NOTES

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994 . CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.20 MM FROM TERMINAL TIP. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

|     | MULIMETERS  |      |  |  |  |
|-----|-------------|------|--|--|--|
|     | MILLIMETERS |      |  |  |  |
| DIM | MIN         | MAX  |  |  |  |
| Α   | 0.80        | 1.00 |  |  |  |
| A1  | 0.00        | 0.05 |  |  |  |
| A3  | 0.20        | REF  |  |  |  |
| b   | 0.20 0.30   |      |  |  |  |
| D   | 2.00 BSC    |      |  |  |  |
| D2  | 1.10 1.30   |      |  |  |  |
| E   | 2.00 BSC    |      |  |  |  |
| E2  | 0.70 0.90   |      |  |  |  |
| е   | 0.50 BSC    |      |  |  |  |
| K   | 0.30 REF    |      |  |  |  |
| L   | 0.25 0.35   |      |  |  |  |
| L1  | 0.10        |      |  |  |  |

# **GENERIC MARKING DIAGRAM\***



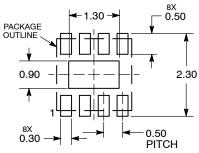
XX = Specific Device Code

= Date Code = Pb-Free Device

\*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

# **RECOMMENDED SOLDERING FOOTPRINT\***



**DIMENSIONS: MILLIMETERS** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|----------------------------|--|-------------|--|
| DESCRIPTION:     | DFN8, 2.0X2.0, 0.5MM PITCH |  | PAGE 1 OF 1 |  |

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SOIC-8 NB CASE 751-07 **ISSUE AK** 

**DATE 16 FEB 2011** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

|     | MILLIMETERS |      | MILLIMETERS INCHES |       |
|-----|-------------|------|--------------------|-------|
| DIM | MIN         | MAX  | MIN                | MAX   |
| Α   | 4.80        | 5.00 | 0.189              | 0.197 |
| В   | 3.80        | 4.00 | 0.150              | 0.157 |
| С   | 1.35        | 1.75 | 0.053              | 0.069 |
| D   | 0.33        | 0.51 | 0.013              | 0.020 |
| G   | 1.27 BSC    |      | 0.050 BSC          |       |
| Н   | 0.10        | 0.25 | 0.004              | 0.010 |
| J   | 0.19        | 0.25 | 0.007              | 0.010 |
| K   | 0.40        | 1.27 | 0.016              | 0.050 |
| М   | 0 °         | 8 °  | 0 °                | 8 °   |
| N   | 0.25        | 0.50 | 0.010              | 0.020 |
| S   | 5.80        | 6.20 | 0.228              | 0.244 |

# **SOLDERING FOOTPRINT\***



<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location

= Wafer Lot = Year = Work Week

= Pb-Free Package



XXXXXX = Specific Device Code = Assembly Location Α

= Year ww = Work Week

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

# **STYLES ON PAGE 2**

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# SOIC-8 NB CASE 751-07 ISSUE AK

# DATE 16 FEB 2011

| STYLE 3: PIN 1. DRAIN, PIE #1 CTOR, #1 CTOR, #2 CTOR, #1 CTOR, #2 CTOR, #2 CTOR, #2 CTOR, #2 CTOR, #1 | 2. ANODE 3. ANODE 4. ANODE 5. ANODE 6. ANODE 7. ANODE 8. COMMON CATHODE  STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2 4. COLLECTOR, #2 5. COLLECTOR, #2 6. EMITTER, #1 Vd  STYLE 12: PIN 1. SOURCE 2. SOURCE 3. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN 8. TYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #1 |
|---|---|
| E PIN 1. INPUT 2. EXTERNAL BY 3. THIRD STAGE 4. GROUND E 5. DRAIN 6. GATE 3 7. SECOND STAGE 8. FIRST STAGE STYLE 11: ID PIN 1. SOURCE 1 2. GATE 1 T 3. SOURCE 2 ID 4. GATE 2 ID 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1 ID 8. DRAIN 1 ID | PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2 4. COLLECTOR, #2 5. COLLECTOR, #2 6. EMITTER, #2 7. EMITTER, #1 Vd 8. COLLECTOR, #1  STYLE 12: PIN 1. SOURCE 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN 8. TYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2   |
| ID PIN 1. SOURCE 1 2. GATE 1 T 3. SOURCE 2 ID 4. GATE 2 ID 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1 ID 8. DRAIN 1 STYLE 15: RCE PIN 1. ANODE 1 E 2. ANODE 1 RCE 3. ANODE 1  | PIN 1. SOURCE 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2   |
| STYLE 15:  RCE PIN 1. ANODE 1 E 2. ANODE 1 RCE 3. ANODE 1   | PIN 1. EMITTER, DIE #1<br>2. BASE, DIE #1<br>3. EMITTER, DIE #2   |
| N 7. CATHODE, CON<br>N 8. CATHODE, CON  | MMON         5. COLLECTOR, DIE #2           MMON         6. COLLECTOR, DIE #2           MMON         7. COLLECTOR, DIE #1           MMON         8. COLLECTOR, DIE #1   |
| STYLE 19: PIN 1. SOURCE 1 E 2. GATE 1 E 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. MIRROR 2 DE 7. DRAIN 1 DE 8. MIRROR 1   | STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P) 4. GATE (P) 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN   |
| STYLE 23: E1 PIN 1. LINE 1 IN DN CATHODE/VCC 2. COMMON ANC DN CATHODE/VCC 3. COMMON ANC E3 4. LINE 2 IN DN ANODE/GND 5. LINE 2 OUT E4 6. COMMON ANC E5 7. COMMON ANC DN ANODE/GND 8. LINE 1 OUT   | ODE/GND 2. EMITTER ODE/GND 3. COLLECTOR/ANODE   |
| STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN  | STYLE 28: PIN 1. SW_TO_GND 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V MON 6. VBULK 7. VBULK 8. VIN  |
| 1<br>1  |   |
| ;   | STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ E 5. SOURCE E 6. SOURCE E 7. SOURCE 8. DRAIN  |

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# **TSSOP 8 CASE 948R-02 ISSUE A**

# **DATE 04/07/2000**







- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH. OR GATE BURRS SHALL NOT EXCEED 0.15
- (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
  6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

|     | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
| DIM | MIN         | MAX  | MIN       | MAX   |
| Α   | 2.90        | 3.10 | 0.114     | 0.122 |
| В   | 2.90        | 3.10 | 0.114     | 0.122 |
| С   | 0.80        | 1.10 | 0.031     | 0.043 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.40        | 0.70 | 0.016     | 0.028 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| K   | 0.25        | 0.40 | 0.010     | 0.016 |
| L   | 4.90 BSC    |      | 0.193 BSC |       |
| M   | ٥°          | 6 °  | ٥°        | 6°    |

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